



**CHENMKO ENTERPRISE CO.,LTD**

Halogens free devices

**SURFACE MOUNT**  
**P-Channel Enhancement Mode Field Effect Transistor**  
**VOLTAGE 20 Volts CURRENT 3.5 Ampere**

**CHM3413KGP**

#### APPLICATION

- \* Servo motor control.
- \* Power MOSFET gate drivers.
- \* Other switching applications.

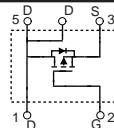
#### FEATURE

- \* Small flat package. (SC-88A )
- \* High density cell design for extremely low  $R_{DS(ON)}$ .
- \* Rugged and reliable.
- \* High saturation current capability.

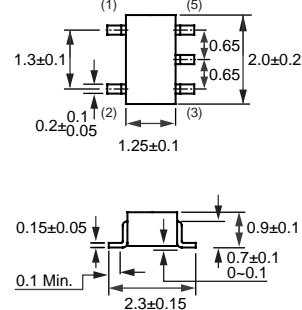
#### CONSTRUCTION

- \* P-Channel Enhancement

#### CIRCUIT



**SC-88A/SOT-353**



Dimensions in millimeters

**SC-88A/SOT-353**

#### Absolute Maximum Ratings

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	CHM3413KGP	Units
$V_{DSS}$	Drain-Source Voltage	-20	V
$V_{GSS}$	Gate-Source Voltage	$\pm 12$	V
$I_D$	Maximum Drain Current - Continuous	-3.5	A
	- Pulsed	-15	
$P_D$	Maximum Power Dissipation	625	mW
$T_J$	Operating Temperature Range	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$

#### Thermal characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	250	$^\circ\text{C/W}$
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2007-10

## ELECTRICAL CHARACTERISTIC ( CHM3413KGP )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -20 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			-1	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage	$V_{\text{GS}} = 12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			+100	nA
$I_{\text{GSSR}}$	Gate-Body Leakage	$V_{\text{GS}} = -12 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			-100	nA

### ON CHARACTERISTICS (Note 2)

$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	-0.36		-0.8	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = -4.5 \text{ V}, I_D = -3.4 \text{ A}$		76	95	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5 \text{ V}, I_D = -2.4 \text{ A}$		97	120	
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, I_D = -2.8 \text{ A}$		6		S

### SWITCHING CHARACTERISTICS (Note 4)

$Q_g$	Total Gate Charge	$V_{\text{DS}} = -6 \text{ V}, I_D = -2.8 \text{ A}$ $V_{\text{GS}} = -4.5 \text{ V}$		4.8	8	nC
$Q_{\text{gs}}$	Gate-Source Charge			1		
$Q_{\text{gd}}$	Gate-Drain Charge			1		
$t_{\text{on}}$	Turn-On Time	$V_{\text{DD}} = -6 \text{ V}$ $I_D = -1.0 \text{ A}, V_{\text{GEN}} = -4.5 \text{ V}$ $R_G = 6 \Omega$		10	16	nS
$t_r$	Rise Time			13	23	
$t_{\text{off}}$	Turn-Off Time			18	25	
$t_f$	Fall Time			15	20	

### DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

$I_s$	Drain-Source Diode Forward Current				-1.5	A
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$I_s = -1.5 \text{ A}, V_{\text{GS}} = 0 \text{ V}$			-1.2	V